

Product Description

The PE42521 SPDT absorptive RF switch is designed for use in Test/ATE and other high performance wireless applications. This broadband general purpose switch maintains excellent RF performance and linearity from 9 kHz through 13 GHz. This switch is a pin-compatible upgraded version of PE42552 with fast switching time and higher power handling of 36 dBm continuous wave (CW) and 38.5 dBm instantaneous power in 50Ω @ 4 GHz. The PE42521 exhibits high isolation, fast settling time, and is offered in a 3x3 mm QFN package.

The PE42521 is manufactured on Peregrine’s UltraCMOS® process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Features

- HaRP™ technology enhanced
 - Fast settling time of 2 μs
 - No gate and phase lag
 - No drift in insertion loss and phase
- Fast switching time of 500 ns
- High power handling @ 4 GHz in 50Ω
 - 36 dBm CW
 - 38.5 dBm instantaneous power
 - 26 dBm terminated port
- High linearity
 - 65 dBm IIP3
- Low insertion loss
 - 0.75 dB @ 3 GHz
 - 1.15 dB @ 10 GHz
 - 1.85 dB @ 13 GHz
- High isolation
 - 44 dB @ 3 GHz
 - 30 dB @ 10 GHz
 - 17 dB @ 13 GHz
- ESD performance
 - 3kV HBM on RF pins to GND
 - 1.5kV HBM on all pins
 - 1kV CDM on all pins

Figure 1. Functional Diagram

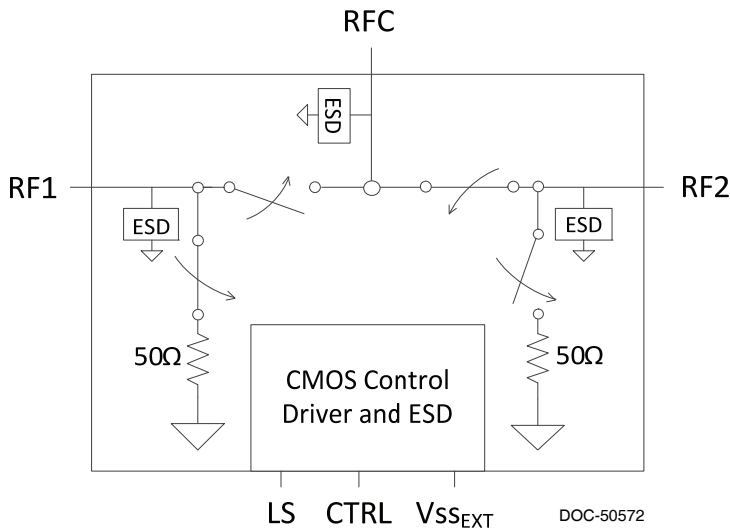


Figure 2. Package Type
16-lead 3x3 mm QFN

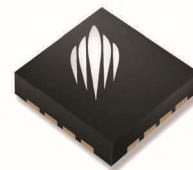


Table 1. Electrical Specifications @ 25°C, V_{DD} = 3.3V, V_{SS}EXT = 0V or V_{DD} = 3.4V, V_{SS}EXT = -3.4V, (Z_S = Z_L = 50Ω) unless otherwise noted

Parameter	Path	Condition	Min	Typ	Max	Unit
Operation frequency			9 kHz		13 GHz	As shown
Insertion loss	RFC-RFX	9 kHz – 10 MHz		0.60	0.80	dB
		10 MHz – 3 GHz		0.75	1.00	dB
		3 GHz – 7.5 GHz		0.95	1.20	dB
		7.5 GHz – 10 GHz		1.15	1.40	dB
		10 GHz – 12 GHz		1.75	2.20	dB
		12 GHz – 13 GHz		1.85	2.60	dB
Isolation	RFX-RFX	9 kHz – 10 MHz	70	90		dB
		10 MHz – 3 GHz	46	49		dB
		3 GHz – 7.5 GHz	35	37		dB
		7.5 GHz – 10 GHz	23	26		dB
		10 GHz – 12 GHz	16	19		dB
		12 GHz – 13 GHz	14	17		dB
Isolation	RFC-RFX	9 kHz – 10 MHz	80	90		dB
		10 MHz – 3 GHz	42	44		dB
		3 GHz – 7.5 GHz	39	41		dB
		7.5 GHz – 10 GHz	26	30		dB
		10 GHz – 12 GHz	18	21		dB
		12 GHz – 13 GHz	14	17		dB
Return loss (active port)	RFC-RFX	9 kHz – 10 MHz		23		dB
		10 MHz – 3 GHz		19		dB
		3 GHz – 7.5 GHz		16		dB
		7.5 GHz – 10 GHz		21		dB
		10 GHz – 12 GHz		10		dB
		12 GHz – 13 GHz		15		dB
Return loss (common port)	RFC-RFX	9 kHz – 10 MHz		23		dB
		10 MHz – 3 GHz		19		dB
		3 GHz – 7.5 GHz		16		dB
		7.5 GHz – 10 GHz		21		dB
		10 GHz – 12 GHz		10		dB
		12 GHz – 13 GHz		16		dB
Return loss (terminated port)	RFX	9 kHz – 10 MHz		32		dB
		10 MHz – 3 GHz		23		dB
		3 GHz – 7.5 GHz		18		dB
		7.5 GHz – 10 GHz		11		dB
		10 GHz – 12 GHz		6		dB
		12 GHz – 13 GHz		5		dB
Input 0.1 dB compression point ¹	RFC-RFX	600 MHz – 13 GHz		Fig. 5		dBm
Input IP2	RFC-RFX	834 MHz, 1950 MHz		120		dBm
Input IP3	RFC-RFX	834 MHz, 1950 MHz, and 2700 MHz		65		dBm
Settling time		50% CTRL to 0.05 dB final value		2	4	μs
Switching time		50% CTRL to 90% or 10% of final value		500	700	ns

Note 1: The input 0.1 dB compression point is a linearity figure of merit. Refer to Table 3 for the RF input power P_{IN} (50Ω)

Figure 3. Pin Configuration (Top View)

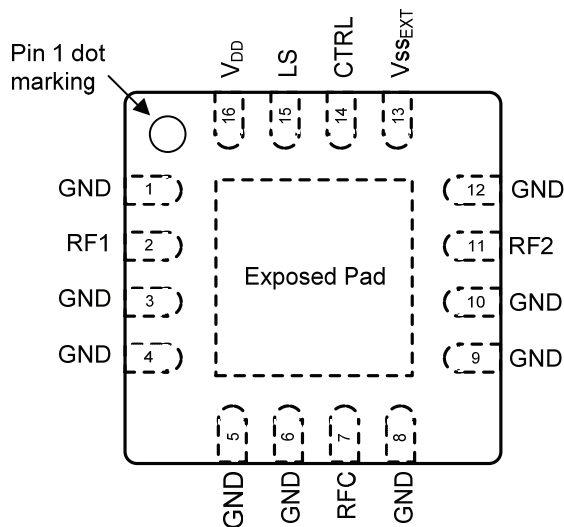


Table 2. Pin Descriptions

Pin #	Pin Name	Description
2	RF1 ¹	RF port 1
1, 3, 4, 5, 6, 8, 9, 10, 12	GND	Ground
7	RFC ¹	RF common
11	RF2 ¹	RF port 2
13	V _{SS} EXT ²	External Vss negative voltage control
14	CTRL	Digital control logic input
15	LS	Logic Select - used to determine the definition for the CTRL pin (see Table 5)
16	V _{DD}	Supply voltage
Pad	GND	Exposed pad: ground for proper operation

Notes: 1. RF pins 2, 7, and 11 must be at 0V DC. The RF pins do not require DC blocking capacitors for proper operation if the 0V DC requirement is met
2. Use V_{SS}EXT (pin 13) to bypass and disable internal negative voltage generator. Connect V_{SS}EXT (pin 13) to GND (V_{SS}EXT = 0V) to enable internal negative voltage generator

Table 3. Operating Ranges

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage (normal mode, V _{SS} EXT = 0V) ¹	V _{DD}	2.3		5.5	V
Supply voltage (bypass mode, V _{SS} EXT = -3.4V, V _{DD} ≥ 3.4V for full spec. compliance) ²	V _{DD}	2.7	3.4	5.5	V
Negative supply voltage (bypass mode) ²	V _{SS} EXT	-3.6		-3.2	V
Supply current (normal mode, V _{SS} EXT = 0V) ¹	I _{DD}		120	200	μA
Supply current (bypass mode, V _{SS} EXT = -3.4V) ²	I _{DD}		50	80	μA
Negative supply current (bypass mode, V _{SS} EXT = -3.4V) ²	I _{SS}	-40	-16		μA
Digital input high (CTRL)	V _{IH}	1.17		3.6	V
Digital input low (CTRL)	V _{IL}	-0.3		0.6	V
Digital input current	I _{CTRL}			10	μA
RF input power, CW (RFC-RFX) ³	P _{IN-CW}				
9 kHz ≤ 600 MHz				Fig. 4	dBm
600 MHz ≤ 4 GHz				36	dBm
4 GHz ≤ 13 GHz				Fig. 5	dBm
RF input power, pulsed (RFC-RFX) ⁴	P _{IN-PULSED}				
9 kHz ≤ 600 MHz				Fig. 4	dBm
600 MHz ≤ 13 GHz				Fig. 5	dBm
RF input power, hot switch, CW ³	P _{IN-HOT}				
9 kHz ≤ 10 MHz				Fig. 4	dBm
10 MHz ≤ 13 GHz				20	dBm
RF input power into terminated ports, CW (RFX) ³	P _{IN,TERM}				
9 kHz ≤ 30 MHz				Fig. 4	dBm
30 MHz ≤ 13 GHz				26	dBm
Operating temperature range	T _{OP}	-40	+25	+85	°C

Notes: 1. Normal mode: connect V_{SS}EXT (pin 13) to GND (V_{SS}EXT = 0V) to enable internal negative voltage generator
2. Bypass mode: use V_{SS}EXT (pin 13) to bypass and disable internal negative voltage generator
3. 100% duty cycle, all bands, 50Ω
4. Pulsed, 5% duty cycle of 4620 μs period, 50Ω

Table 4. Absolute Maximum Ratings

Parameter/Condition	Symbol	Min	Max	Unit
Supply voltage	V_{DD}	-0.3	5.5	V
Digital input voltage (CTRL)	V_{CTRL}	-0.3	3.6	V
LS input voltage	V_{LS}	-0.3	3.6	V
RF input power, CW (RFC-RFX) ¹ 9 kHz ≤ 600 MHz 600 MHz ≤ 4 GHz 4 GHz ≤ 13 GHz	P_{IN-CW}		Fig. 4 36 Fig. 5	dBm dBm dBm
RF input power, pulsed (RFC-RFX) ² 9 kHz ≤ 600 MHz 600 MHz ≤ 13 GHz	$P_{IN-PULSED}$		Fig. 4 Fig. 5	dBm dBm
RF input power into terminated ports, CW (RFX) ¹ 9 kHz ≤ 30 MHz 30 MHz ≤ 13 GHz	$P_{IN-TERM}$		Fig. 4 26	dBm dBm
Storage temperature range	T_{ST}	-65	+150	°C
ESD voltage HBM ³ RF pins to GND All pins	$V_{ESD,HBM}$		3000 1500	V V
ESD voltage MM ⁴ , all pins	$V_{ESD,MM}$		200	V
ESD voltage CDM ⁵ , all pins	$V_{ESD,CDM}$		1000	V

Notes: 1. 100% duty cycle, all bands, 50Ω
2. Pulsed, 5% duty cycle of 4620 μs period, 50Ω
3. Human Body Model (MIL-STD 883 Method 3015)
4. Machine Model (JEDEC JESD22-A115)
5. Charged Device Model (JEDEC JESD22-C101)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS[®] device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS[®] devices are immune to latch-up.

Switching Frequency

The PE42521 has a maximum 25 kHz switching rate when the internal negative voltage generator is used (pin 13 = GND). The rate at which the PE42521 can be switched is only limited to the switching time (*Table 1*) if an external negative supply is provided (pin 13 = V_{SS_EXT}).

Switching frequency describes the time duration between switching events. Switching time is the time duration between the point the control signal reaches 50% of the final value and the point the output signal reaches within 10% or 90% of its target value.

Optional External Vss Control (V_{SS_EXT})

For proper operation, the V_{SS_EXT} control pin must be grounded or tied to the V_{SS} voltage specified in *Table 3*. When the V_{SS_EXT} control pin is grounded, FETs in the switch are biased with an internal negative voltage generator. For applications that require the lowest possible spur performance, V_{SS_EXT} can be applied externally to bypass the internal negative voltage generator.

Spurious Performance

The typical spurious performance of the PE42521 is -135 dBm when $V_{SS_EXT} = 0V$ (pin 13 = GND). If further improvement is desired, the internal negative voltage generator can be disabled by setting $V_{SS_EXT} = -3.4V$.

Table 5. Control Logic Truth Table

LS	CTRL	RFC-RF1	RFC-RF2
0	0	off	on
0	1	on	off
1	0	on	off
1	1	off	on

Moisture Sensitivity Level

The Moisture Sensitivity Level rating for the PE42521 in the 16-lead 3x3 mm QFN package is MSL3.

Logic Select (LS)

The Logic Select feature is used to determine the definition for the CTRL pin.

Figure 4. Power De-rating Curve for 9 kHz – 600 MHz (50Ω)

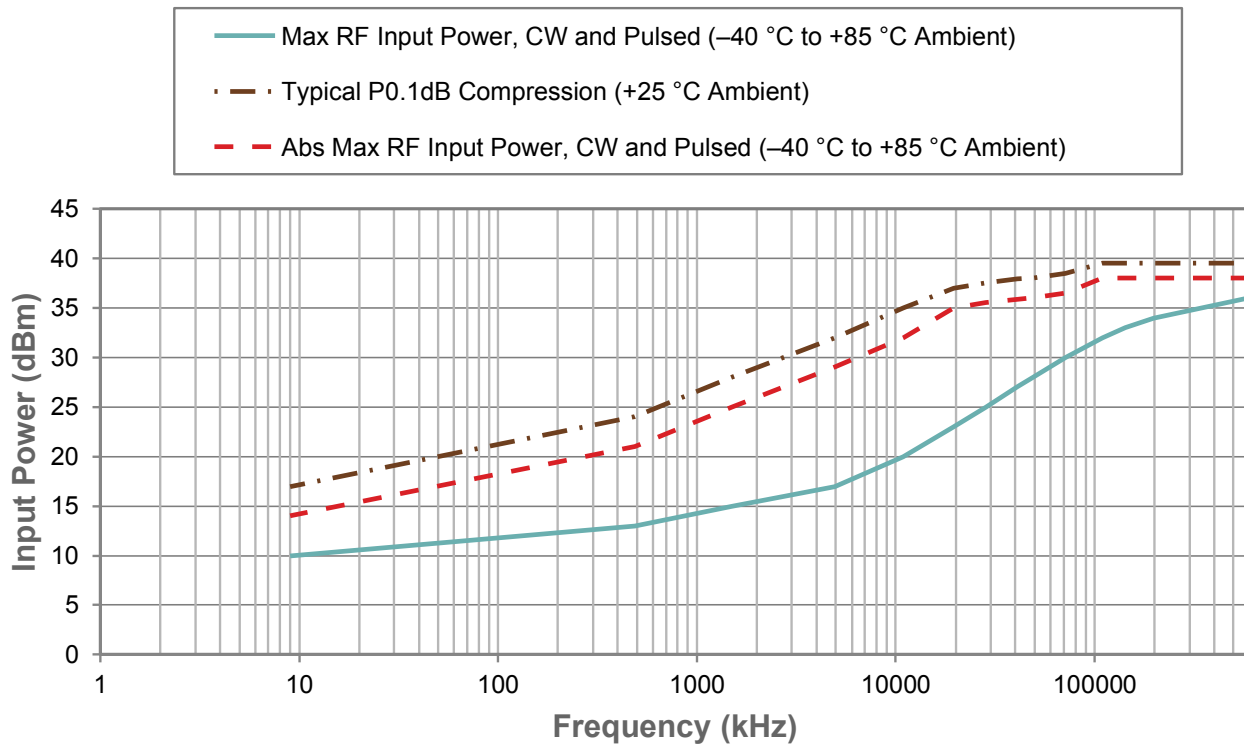


Figure 5a. Power De-rating Curve for 600 MHz – 13 GHz @ 25°C Ambient (50Ω)

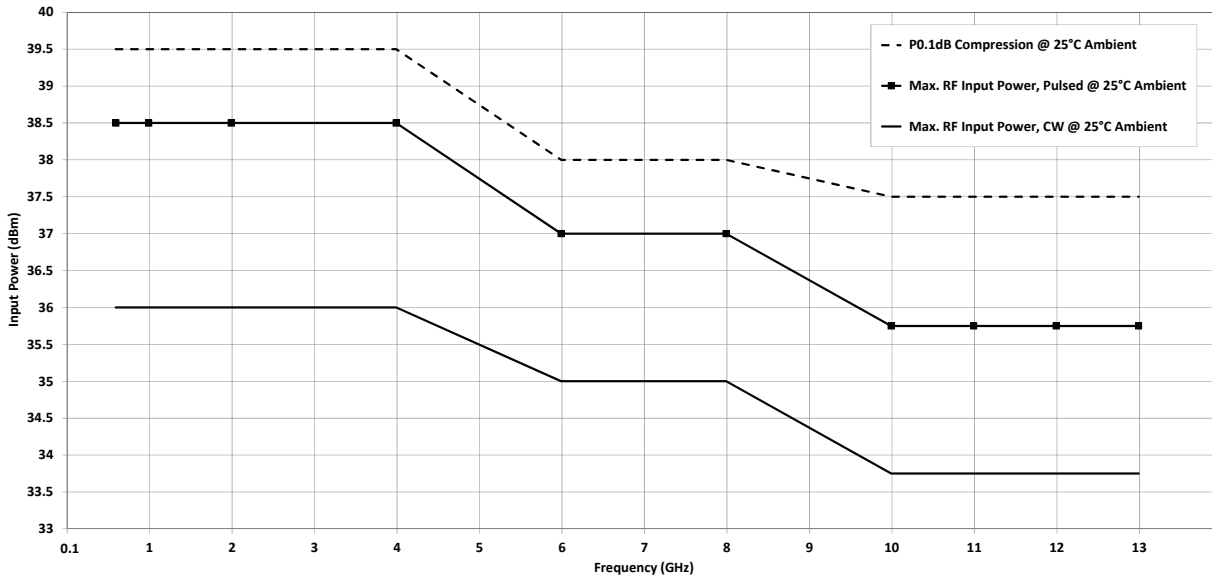
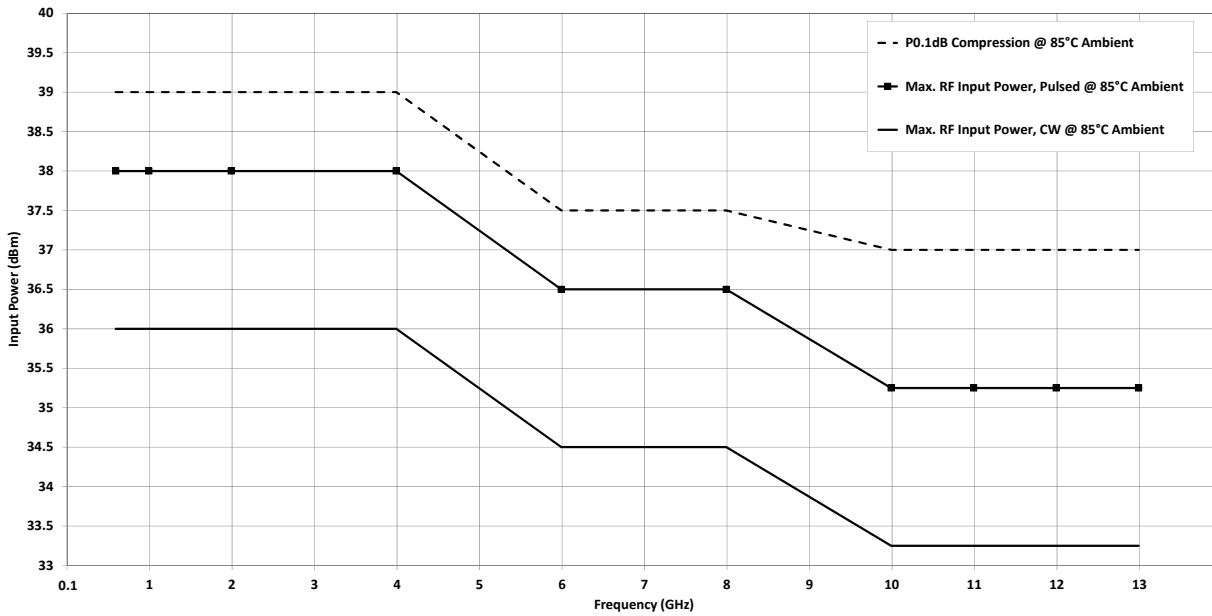


Figure 5b. Power De-rating Curve for 600 MHz – 13 GHz @ 85°C Ambient (50Ω)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 6. Insertion Loss vs. Temp (RFC–RF1)

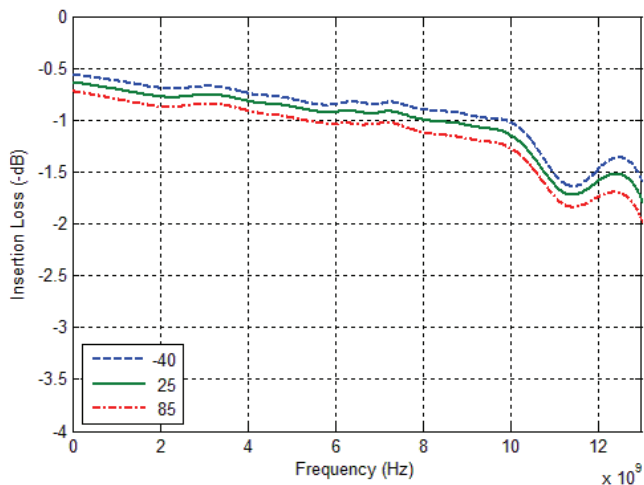


Figure 7. Insertion Loss vs. V_{DD} (RFC–RF1)

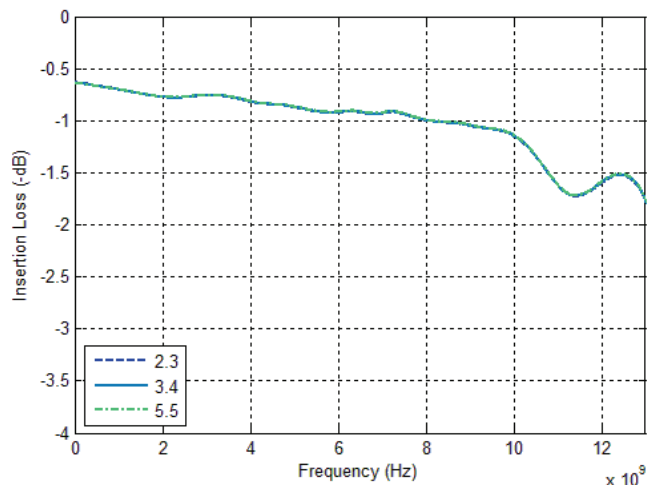


Figure 8. Insertion Loss vs. Temp (RFC–RF2)

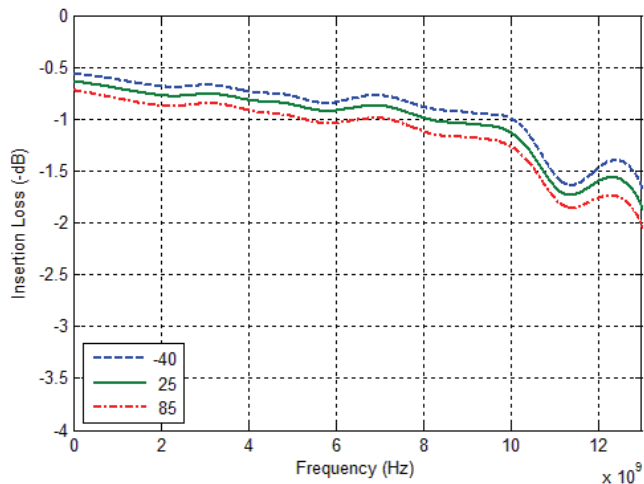
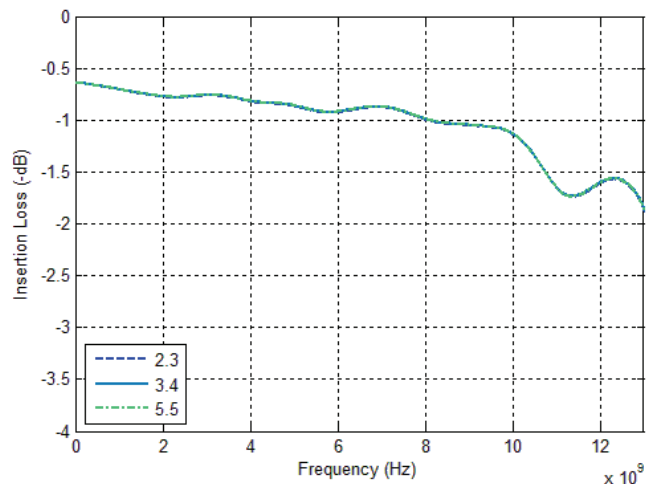


Figure 9. Insertion Loss vs. V_{DD} (RFC–RF2)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 10. RFC Port Return Loss vs. Temp (RF1 Active)

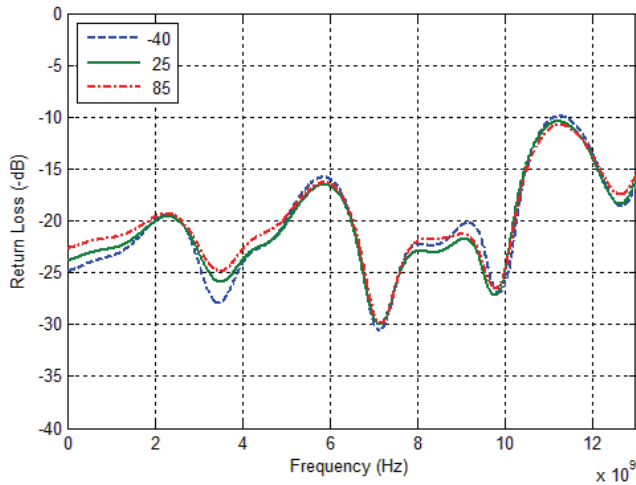


Figure 11. RFC Port Return Loss vs. V_{DD} (RF1 Active)

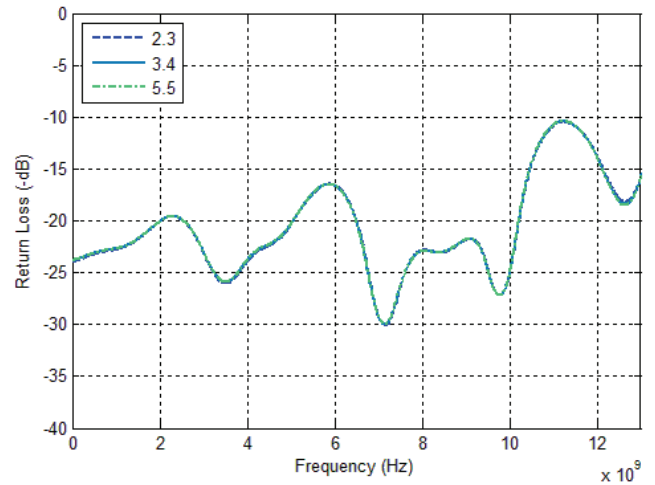


Figure 12. RFC Port Return Loss vs. Temp (RF2 Active)

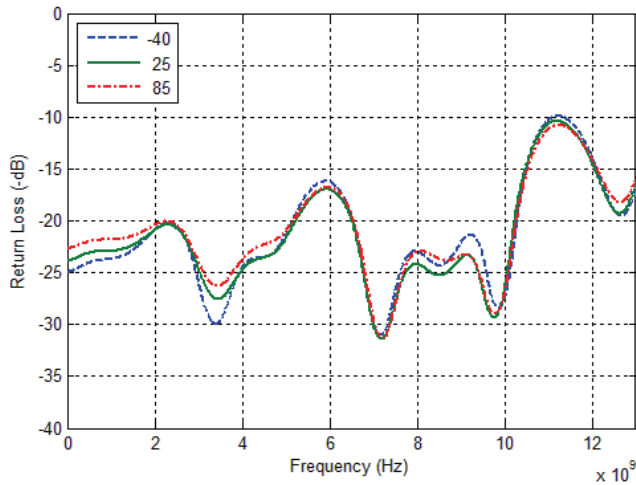
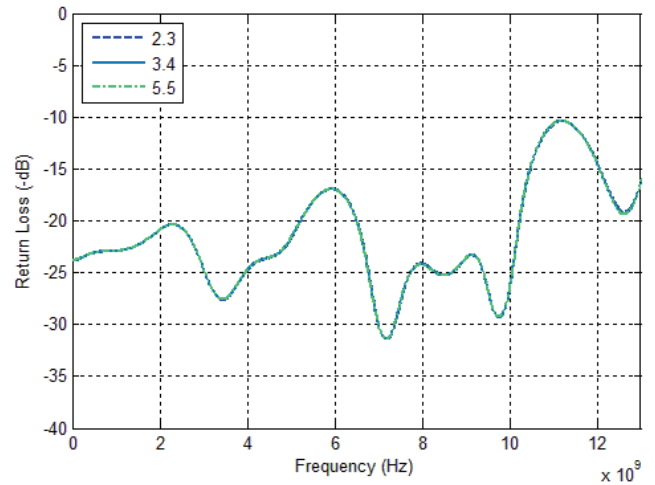


Figure 13. RFC Port Return Loss vs. V_{DD} (RF2 Active)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 14. Active Port Return Loss vs. Temp (RF1 Active)

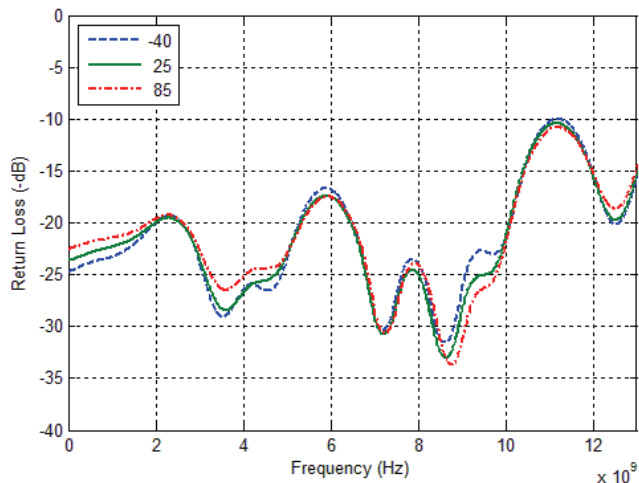


Figure 15. Active Port Return Loss vs. V_{DD} (RF1 Active)

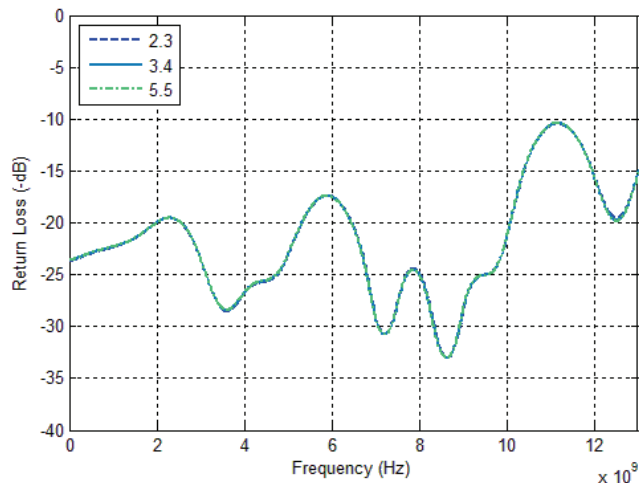


Figure 16. Active Port Return Loss vs. Temp (RF2 Active)

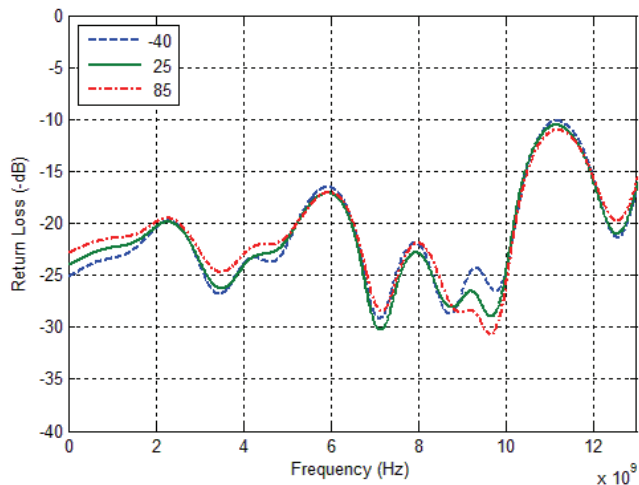
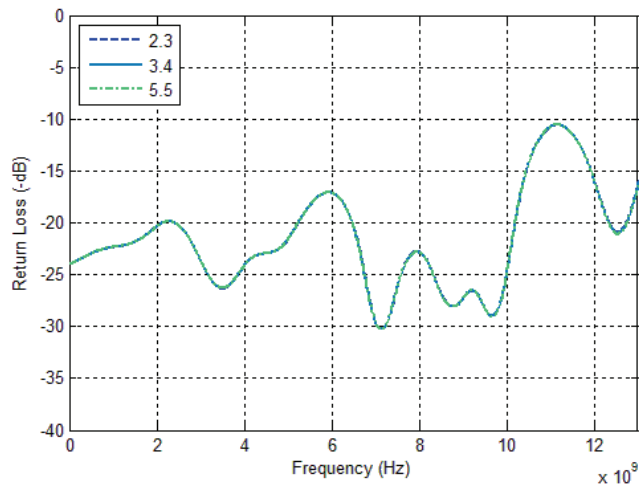


Figure 17. Active Port Return Loss vs. V_{DD} (RF2 Active)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 18. Terminated Port Return Loss vs. Temp (RF1 Active)

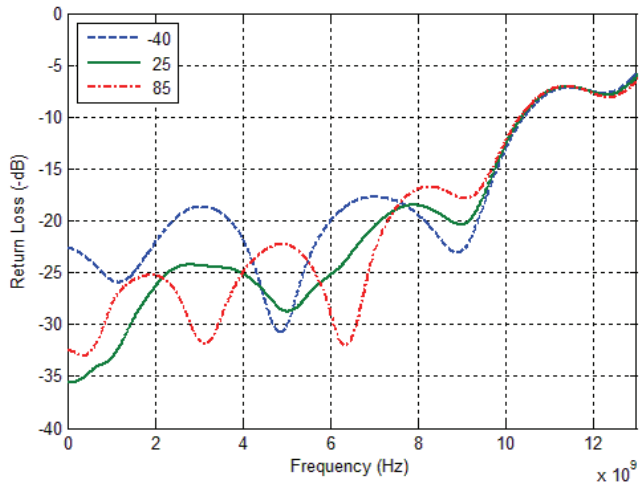


Figure 19. Terminated Port Return Loss vs. V_{DD} (RF1 Active)

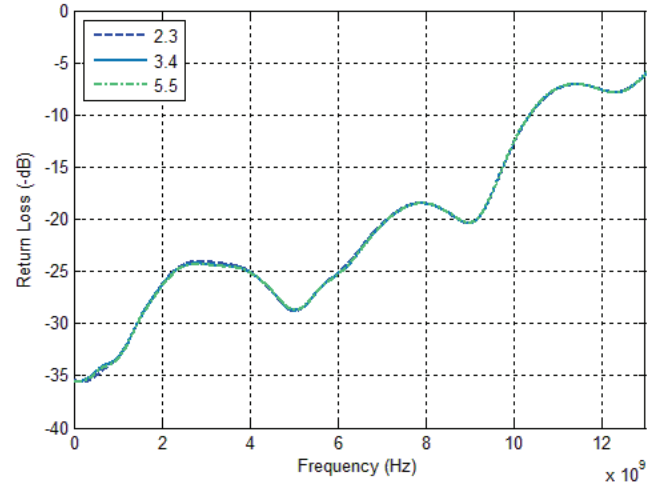


Figure 20. Terminated Port Return Loss vs. Temp (RF2 Active)

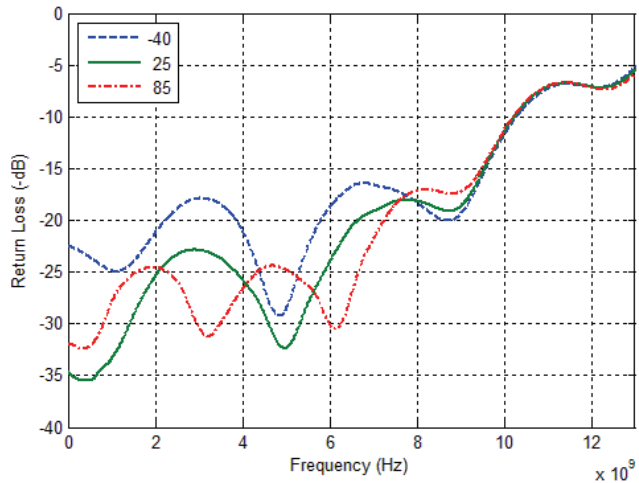
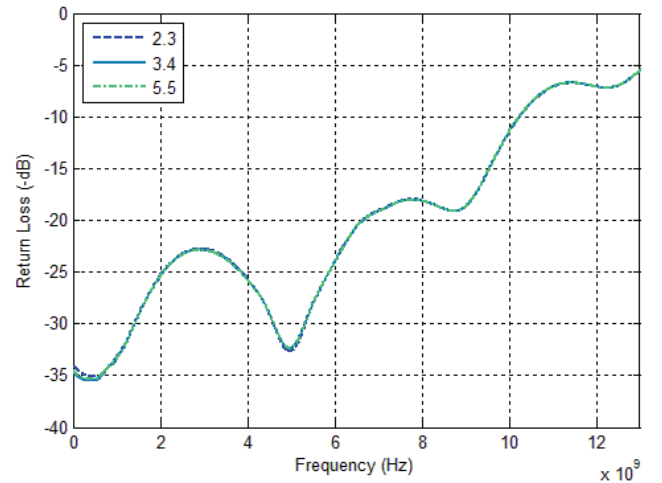


Figure 21. Terminated Port Return Loss vs. V_{DD} (RF2 Active)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 22. Isolation vs. Temp
(RF1–RF2, RF1 Active)

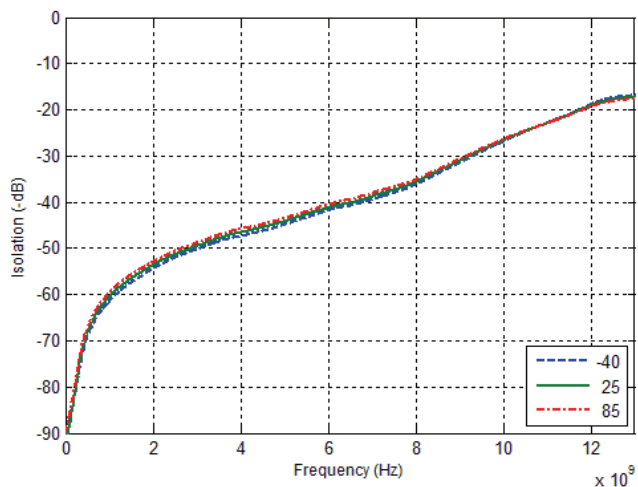


Figure 23. Isolation vs. V_{DD}
(RF1–RF2, RF1 Active)

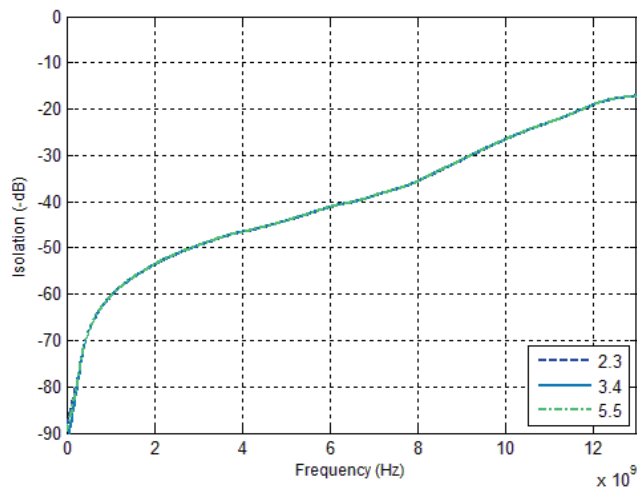


Figure 24. Isolation vs. Temp
(RF2–RF1, RF2 Active)

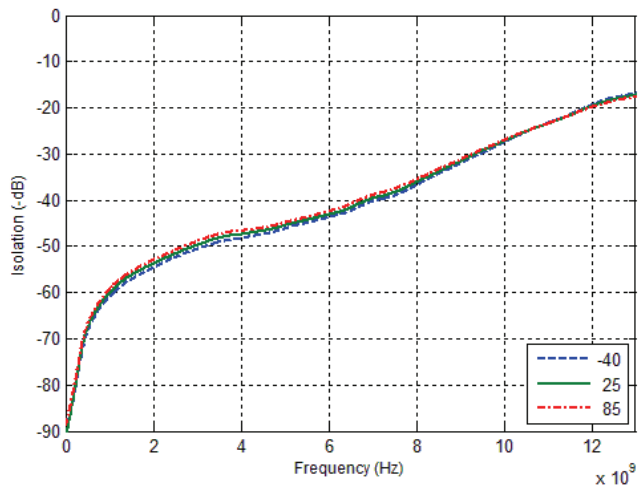
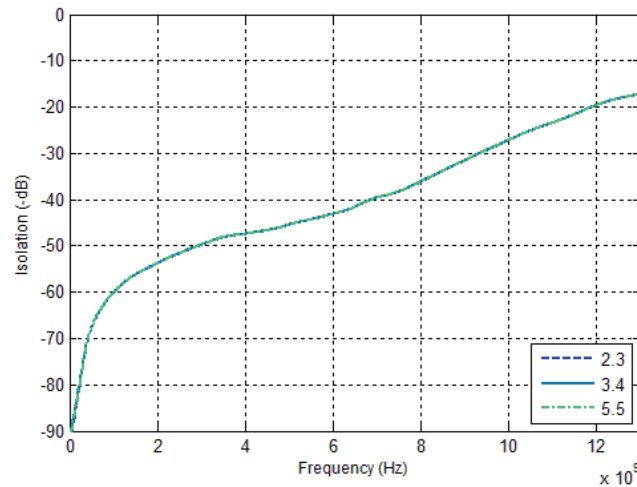


Figure 25. Isolation vs. V_{DD}
(RF2–RF1, RF2 Active)



Typical Performance Data @ 25°C and $V_{DD} = 3.4V$ unless otherwise specified

Figure 26. Isolation vs. Temp
(RFC–RF2, RF1 Active)

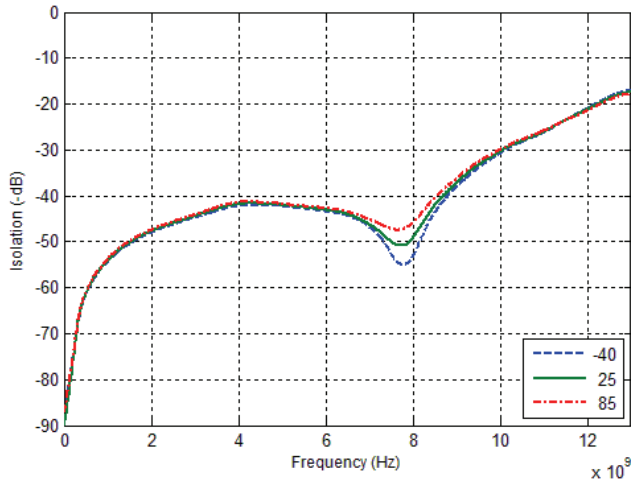


Figure 27. Isolation vs. V_{DD}
(RFC–RF2, RF1 Active)

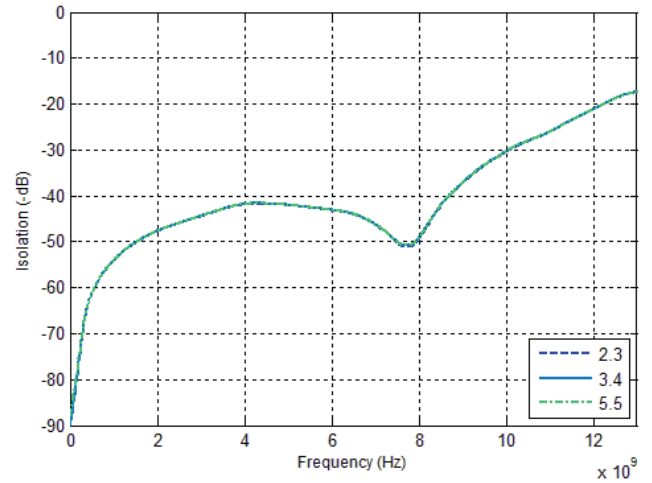


Figure 28. Isolation vs. Temp
(RFC–RF1, RF2 Active)

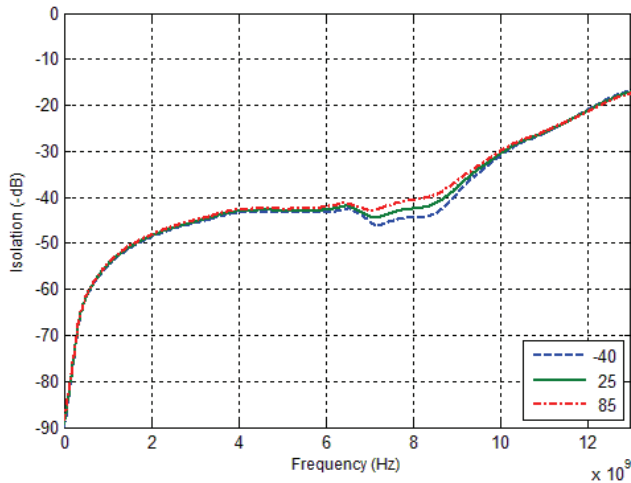
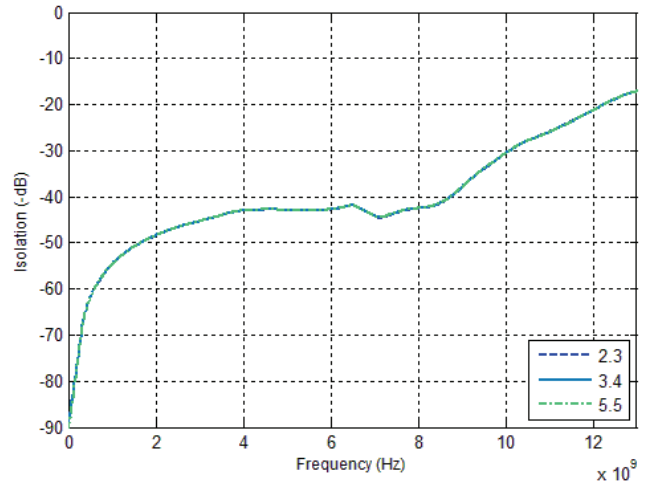


Figure 29. Isolation vs. V_{DD}
(RFC–RF1, RF2 Active)

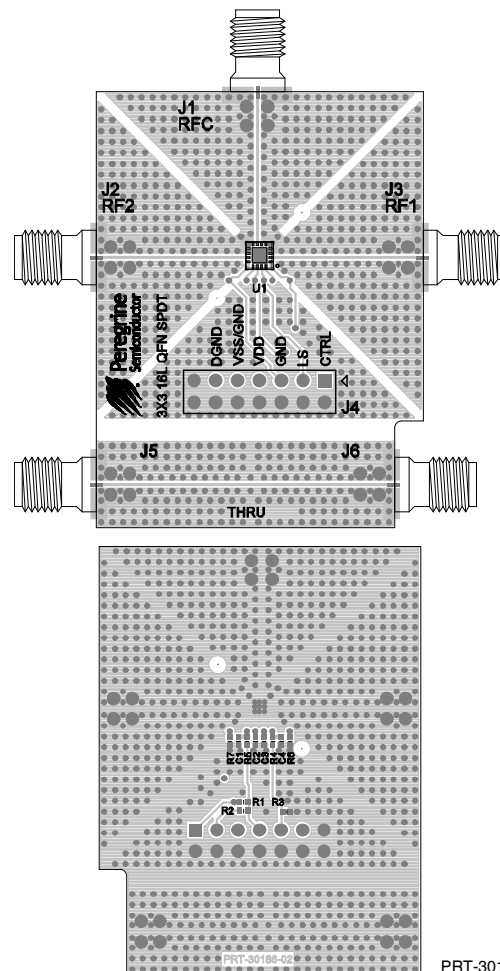


Evaluation Kit

The SPDT switch evaluation board was designed to ease customer evaluation of Peregrine’s PE42521. The RF common port is connected through a 50Ω transmission line via the SMA connector, J1. RF1 and RF2 ports are connected through 50Ω transmission lines via SMA connectors J2 and J3, respectively. A 50Ω through transmission line is available via SMA connectors J5 and J6, which can be used to de-embed the loss of the PCB. J4 provides DC and digital inputs to the device.

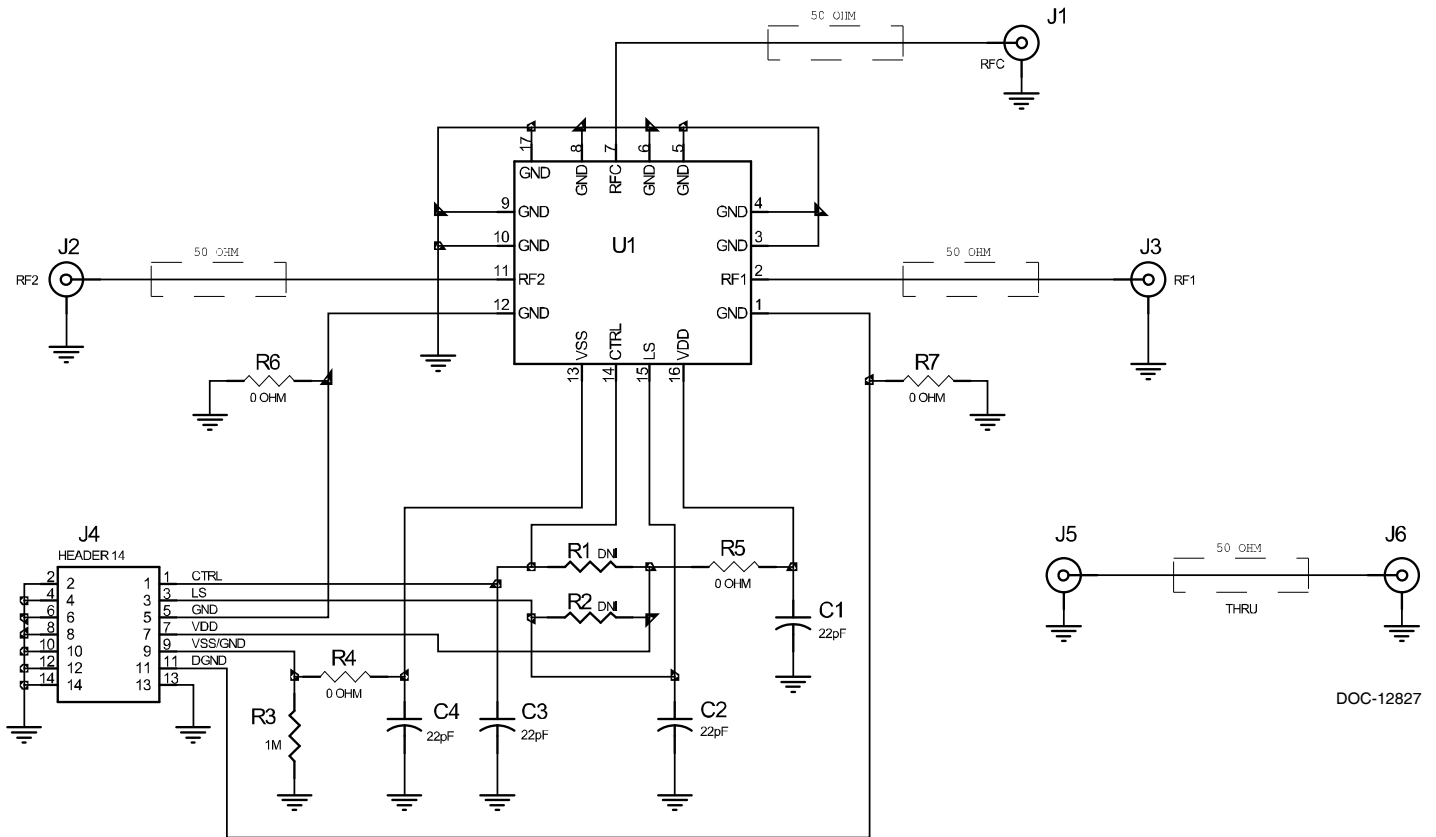
For the true performance of the PE42521 to be realized, the PCB should be designed in such a way that RF transmission lines and sensitive DC I/O traces are heavily isolated from one another.

Figure 30. Evaluation Kit Layout



PRT-30186

Figure 31. Evaluation Board Schematic



- Notes:
1. Use PRT-30186-02 PCB
 2. CAUTION: Contains parts and assemblies susceptible to damage by electrostatic discharge (ESD)

Figure 32. Package Drawing
16-lead 3x3 mm QFN

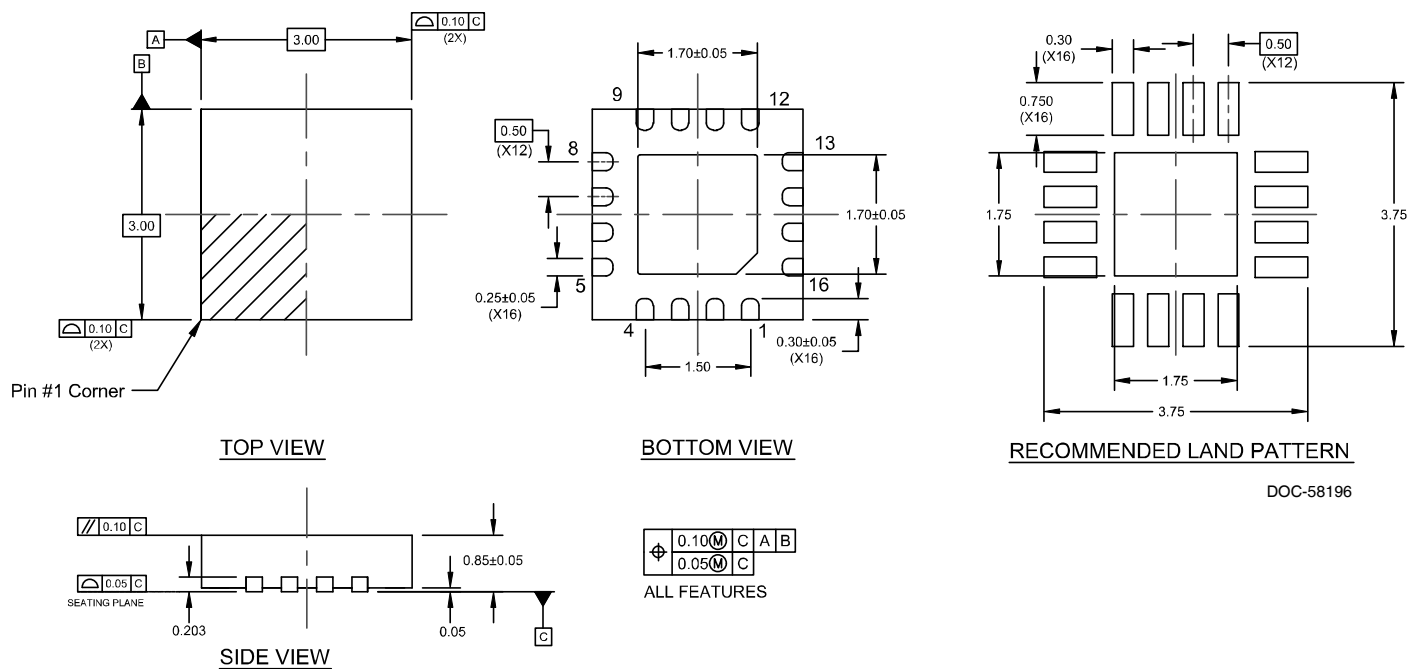
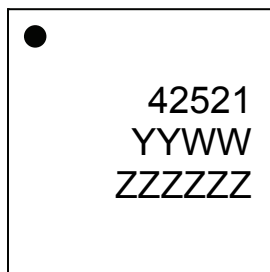


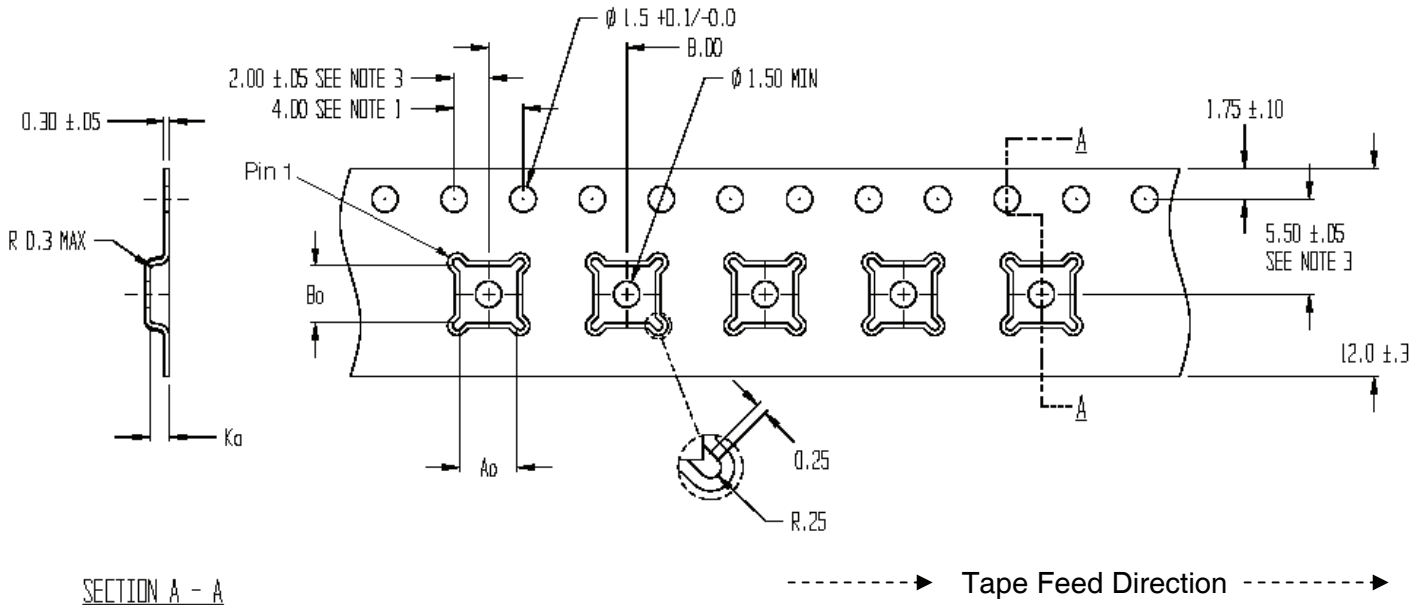
Figure 33. Top Marking Specifications



DOC-66053

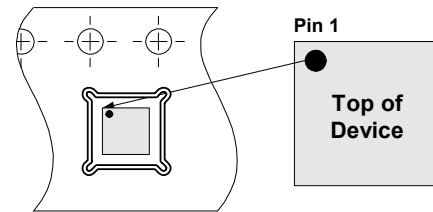
- = Pin 1 designator
- YY = Last two digits of assembly year
- WW = Assembly work week
- ZZZZZZ = Assembly lot code (maximum six characters)

Figure 34. Tape and Reel Specifications



- Notes: 1. 10 sprocket hole pitch cumulative tolerance ± 0.2
 2. Camber in compliance with EIA 481
 3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole

$A_o = 3.30$
 $B_o = 3.30$
 $K_o = 1.10$



Device Orientation in Tape

Table 6. Ordering Information

Order Code	Description	Package	Shipping Method
PE42521C-Z	PE42521 SPDT RF switch	Green 16-lead 3x3 mm QFN	3000 units/T&R
EK42521-03	PE42521 Evaluation kit	Evaluation kit	1/Box

Sales Contact and Information

For sales and contact information please visit www.psemi.com.

Advance Information: The product is in a formative or design stage. The datasheet contains design target specifications for product development. Specifications and features may change in any manner without notice.
Preliminary Specification: The datasheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.
Product Specification: The datasheet contains final data. In the event Peregrine decides to change the specifications, Peregrine will notify customers of the intended changes by issuing a CNF (Customer Notification Form).
 The information in this datasheet is believed to be reliable. However, Peregrine assumes no liability for the use of this information. Use shall be entirely at the user's own risk.

No patent rights or licenses to any circuits described in this datasheet are implied or granted to any third party. Peregrine's products are not designed or intended for use in devices or systems intended for surgical implant, or in other applications intended to support or sustain life, or in any application in which the failure of the Peregrine product could create a situation in which personal injury or death might occur. Peregrine assumes no liability for damages, including consequential or incidental damages, arising out of the use of its products in such applications.
 The Peregrine name, logo, UltraCMOS and UTSi are registered trademarks and HaRP, MultiSwitch and DuNE are trademarks of Peregrine Semiconductor Corp. Peregrine products are protected under one or more of the following U.S. Patents: <http://patents.psemi.com>.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [RF Switch ICs](#) category:

Click to view products by [pSemi](#) manufacturer:

Other Similar products are found below :

[MASW-008853-TR3000](#) [BGS13SN8E6327XTSA1](#) [BGSX210MA18E6327XTSA1](#) [SKY13446-374LF](#) [SW-227-PIN](#) [CG2185X2](#) [CG2415M6](#)
[MA4SW410](#) [MA4SW410B-1](#) [MASW-002102-13580G](#) [MASW-008543-001SMB](#) [MASW-008955-TR3000](#) [TGS4307](#) [BGS 12PL6 E6327](#)
[BGS1414MN20E6327XTSA1](#) [BGS1515MN20E6327XTSA1](#) [BGSA11GN10E6327XTSA1](#) [BGSX28MA18E6327XTSA1](#) [HMC199AMS8](#)
[HMC986A](#) [SKY13374-397LF](#) [SKY13453-385LF](#) [CG2430X1-C2](#) [CG2415M6-C2](#) [HMC986A-SX](#) [SW-314-PIN](#) [UPG2162T5N-E2-A](#)
[SKY13416-485LF](#) [MASWSS0204TR-3000](#) [MASWSS0201TR](#) [MASWSS0181TR-3000](#) [MASW-007588-TR3000](#) [MASW-004103-13655P](#)
[MASW-003102-13590G](#) [MASWSS0202TR-3000](#) [MA4SW310B-1](#) [MA4SW110](#) [SW-313-PIN](#) [CG2430X1](#) [SKY13321-360LF](#) [SKY13405-](#)
[490LF](#) [BGSF 18DM20 E6327](#) [MMS008PP3](#) [BGS13PN10E6327XTSA1](#) [SKY13319-374LF](#) [BGS14PN10E6327XTSA1](#) [SKY12213-478LF](#)
[SKY13404-466LF](#) [MASW-011060-TR0500](#) [SKYA21024](#)